

MITSUBISHI HVIGBT MODULES

CM800E2C-66H

2nd-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

HIGH POWER SWITCHING USE
INSULATED TYPE

CM800E2C-66H



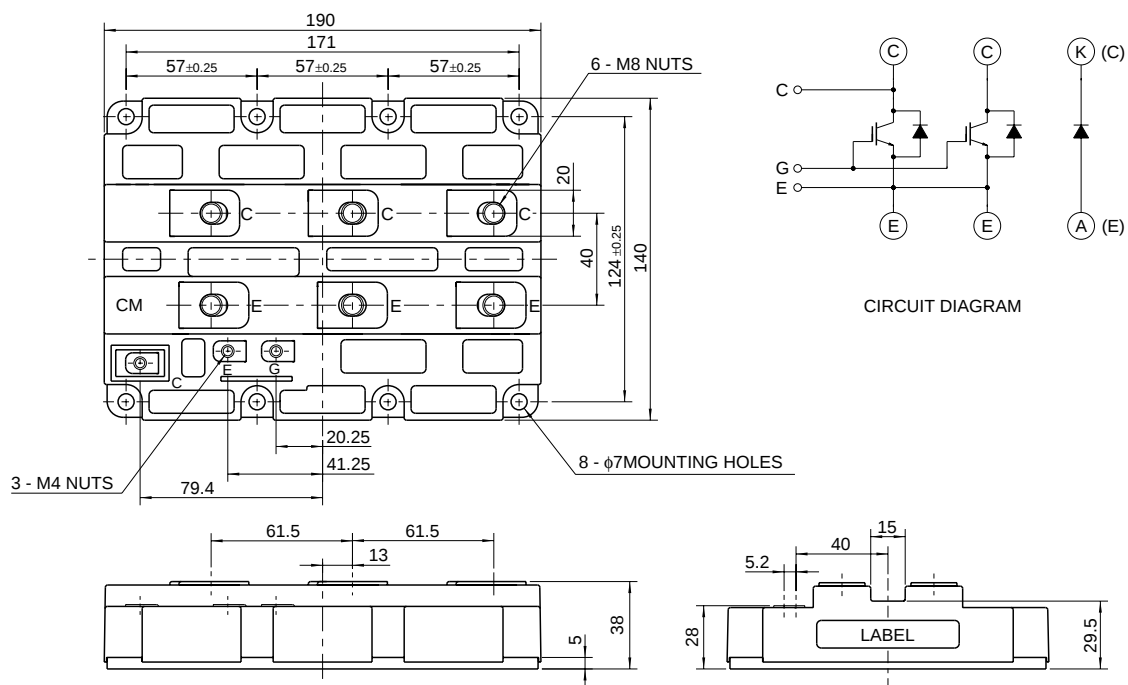
- IC800A
- VCES 3300V
- Insulated Type
- 1-elements in a pack (for brake)
- AISiC base plate

APPLICATION

DC choppers, Dynamic braking choppers.

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



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Mar. 2003

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MAXIMUM RATINGS (Tj = 25°C)

Symbol	Item	Conditions	Ratings	Unit
VCES	Collector-emitter voltage	VGE = 0V	3300	V
VGES	Gate-emitter voltage	VCE = 0V	±20	V
IC	Collector current	DC, Tc = 95°C	800	A
ICM		Pulse (Note 1)	1600	A
IE (Note 2)	Emitter current		800	A
IEM (Note 2)		Pulse (Note 1)	1600	A
PC (Note 3)	Maximum collector dissipation	Tc = 25°C, IGBT part	9600	W
Tj	Junction temperature	—	−40 ~ +150	°C
Tstg	Storage temperature	—	−40 ~ +125	°C
Viso	Isolation voltage	Charged part to base plate, rms, sinusoidal, AC 60Hz 1min.	6000	V
—	Mounting torque	Main terminals screw M8	6.67 ~ 13.00	N·m
		Mounting screw M6	2.84 ~ 6.00	N·m
		Auxiliary terminals screw M4	0.88 ~ 2.00	N·m
—	Mass	Typical value	1.5	kg

ELECTRICAL CHARACTERISTICS (Tj = 25°C)

Symbol	Item	Conditions	Limits			Unit
			Min	Typ	Max	
ICES	Collector cutoff current	VCE = VCES, VGE = 0V	—	—	10	mA
VGE(th)	Gate-emitter threshold voltage	IC = 80mA, VCE = 10V	4.5	6.0	7.5	V
IGES	Gate-leakage current	VGE = VGES, VCE = 0V	—	—	0.5	μA
VCE(sat)	Collector-emitter saturation voltage	Tj = 25°C	—	3.80	4.94	V
		Tj = 125°C	—	4.00	—	
Cies	Input capacitance	VCE = 10V VGE = 0V	—	120	—	nF
Coes	Output capacitance		—	12.0	—	nF
Cres	Reverse transfer capacitance		—	3.6	—	nF
QG	Total gate charge	VCC = 1650V, IC = 800A, VGE = 15V	—	5.7	—	μC
td (on)	Turn-on delay time	VCC = 1650V, IC = 800A	—	—	1.60	μs
tr	Turn-on rise time	VGE1 = VGE2 = 15V	—	—	2.00	μs
td (off)	Turn-off delay time	RG = 2.5Ω	—	—	2.50	μs
tf	Turn-off fall time	Resistive load switching operation	—	—	1.00	μs
VEC (Note 2)	Emitter-collector voltage	IE = 800A, VGE = 0V	—	2.80	3.64	V
trr (Note 2)	Reverse recovery time	IE = 800A	—	—	1.40	μs
Qrr (Note 2)	Reverse recovery charge	die / dt = −1600A / μs	—	270	—	μC
Rth(j-c)Q	Thermal resistance	Junction to case, IGBT part	—	—	0.013	K/W
Rth(j-c)R		Junction to case, FWDi part	—	—	0.025	K/W
Rth(c-f)	Contact thermal resistance	Case to fin, conductive grease applied (Per 2/3 module)	—	0.008	—	K/W
VFM	Forward voltage	IF = 800A, Clamp diode part	—	3.00	3.90	V
trr	Reverse recovery time	IF = 800A	—	—	1.40	μs
Qrr	Reverse recovery charge	di / dt = −1600A / μs, Clamp diode part	—	270	—	μC
Rth(j-c)	Thermal resistance	Junction to case, Clamp diode part	—	—	0.025	K/W
Rth(c-f)	Contact thermal resistance	Case to fin, conductive grease applied (Per 1/3 module)	—	0.008	—	K/W

Note 1. Pulse width and repetition rate should be such that the device junction temp. (Tj) does not exceed Tjmax rating.

2. IE, VEC, trr, Qrr & die/dt represent characteristics of the anti-parallel, emitter to collector free-wheel diode.

3. Junction temperature (Tj) should not increase beyond 150°C.

4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

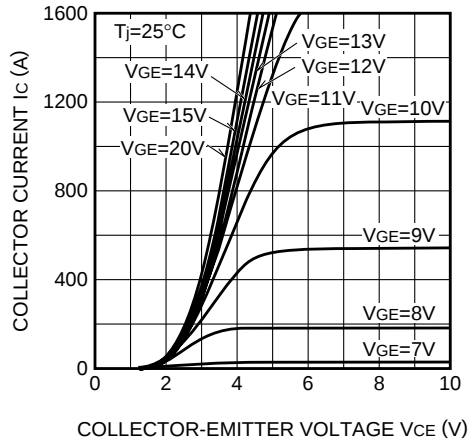
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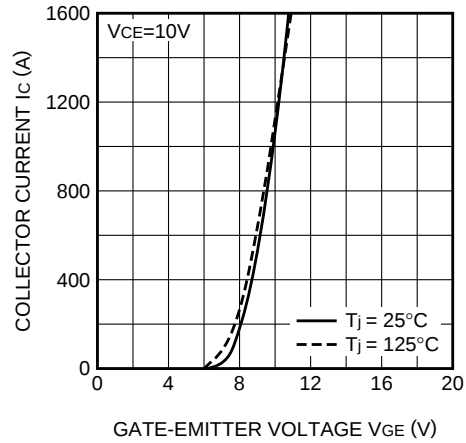
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PERFORMANCE CURVES

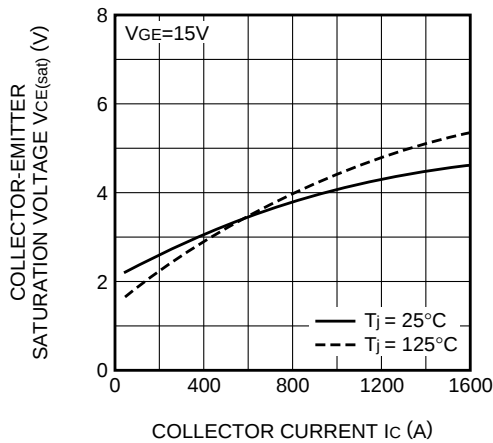
OUTPUT CHARACTERISTICS
(TYPICAL)



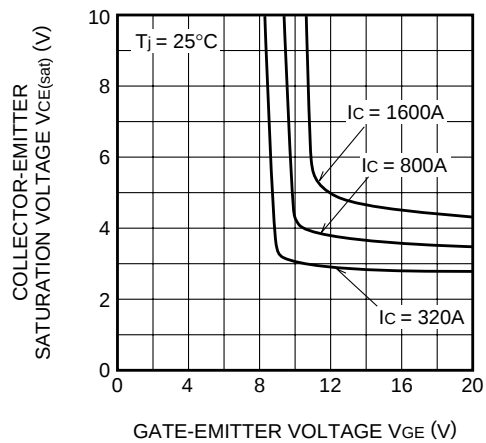
TRANSFER CHARACTERISTICS
(TYPICAL)



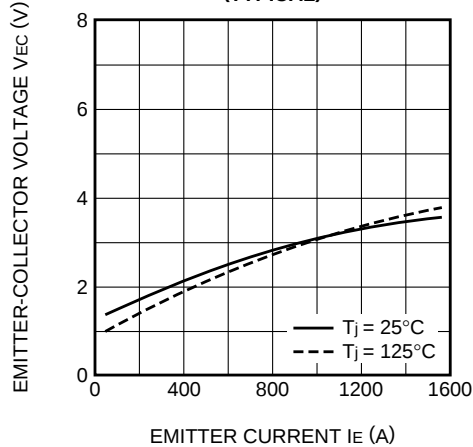
COLLECTOR-EMITTER SATURATION
VOLTAGE CHARACTERISTICS
(TYPICAL)



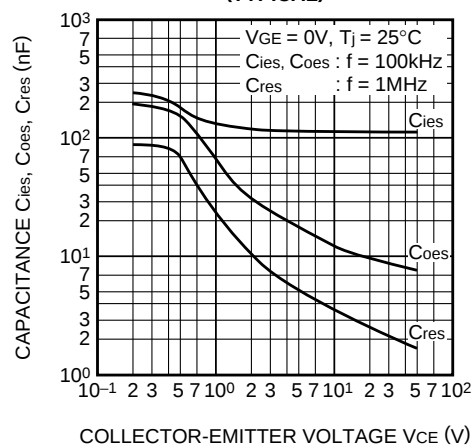
COLLECTOR-EMITTER SATURATION
VOLTAGE CHARACTERISTICS
(TYPICAL)



FREE-WHEEL DIODE
FORWARD CHARACTERISTICS
(TYPICAL)



CAPACITANCE CHARACTERISTICS
(TYPICAL)

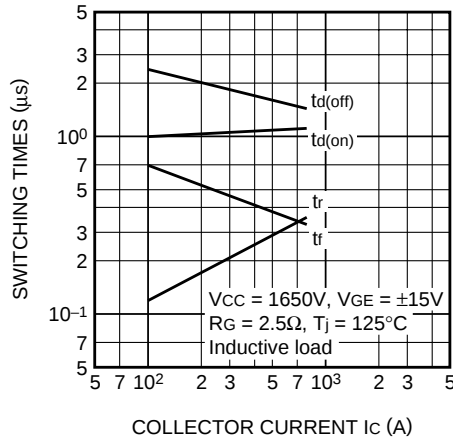


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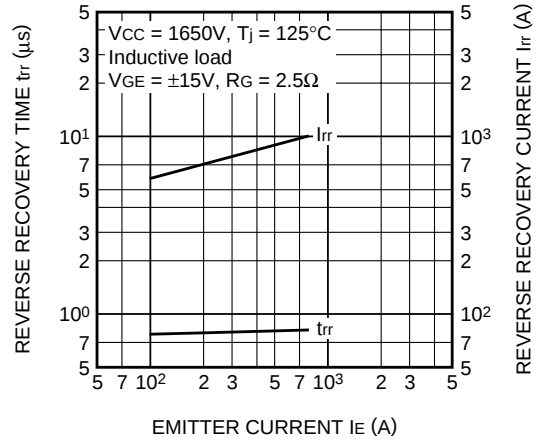
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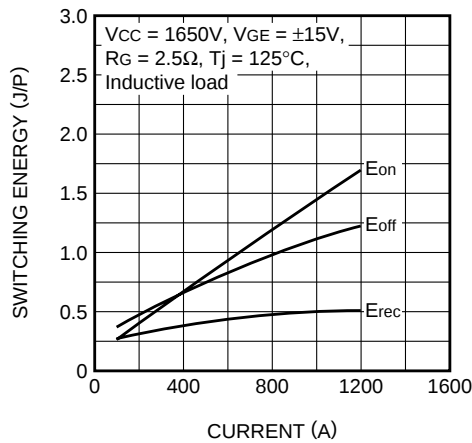
HALF-BRIDGE
SWITCHING TIME CHARACTERISTICS
(TYPICAL)



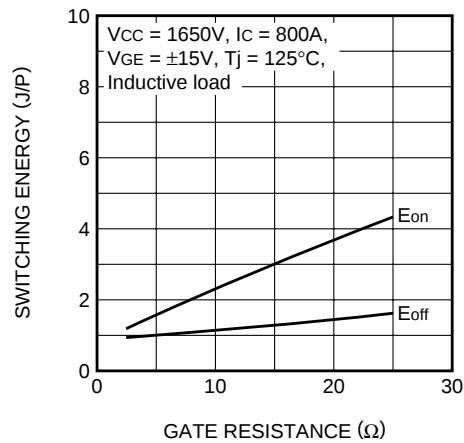
REVERSE RECOVERY CHARACTERISTICS
OF FREE-WHEEL DIODE
(TYPICAL)



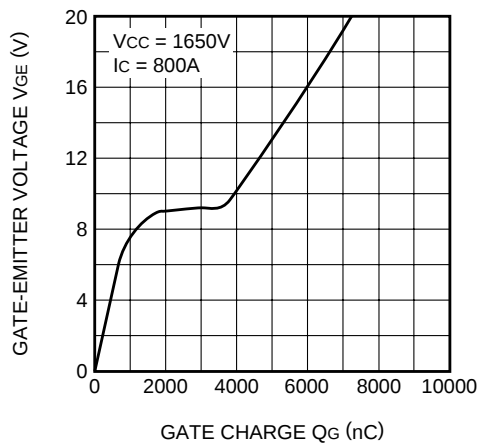
HALF-BRIDGE
SWITCHING ENERGY CHARACTERISTICS
(TYPICAL)



HALF-BRIDGE
SWITCHING ENERGY CHARACTERISTICS
(TYPICAL)



GATE CHARGE CHARACTERISTICS
(TYPICAL)



TRANSIENT THERMAL
IMPEDANCE CHARACTERISTICS

